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John J. Relly, Jr. Reg. No.: 29,182

Examiner : Alonzo Chambliss

Art Unit : 2827

Docket No.: 52433/609

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: K. TATSUMI et al.

Serial No.: 09/632,910

Filed: August 4, 2000

For : METHOD FOR FABRICATING A SEMICONDUCTOR DEVICE

PROVIDED WITH LOW MELTING POINT METAL BUMPS

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

AMENDMENT

SIR:

Reconsideration of the above-identified patent application, as amended, is respectfully requested. The present amendment is responsive to the Office Action mailed March 22, 2004. A petition for an extension of time in which to respond to the Office Action accompanies this amendment.